



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

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Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



PRODUCT NUMBER  
10007607-YXX-XXLF

WHEN REQUIRED, ADD SUFFIX LETTER "LF"  
INDICATES THE PRODUCT IS RoHS COMPATIBLE  
SEE NOTE 5

TOTAL NB OF POSITIONS 02 TO 36

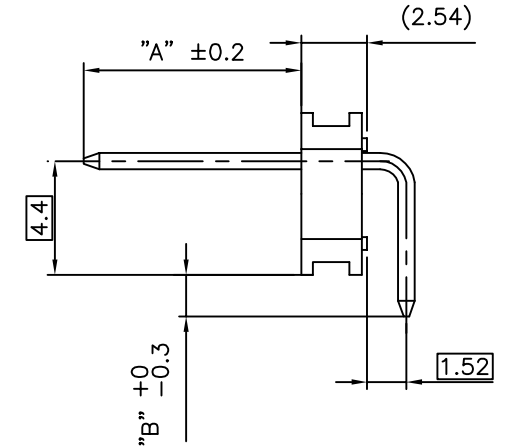
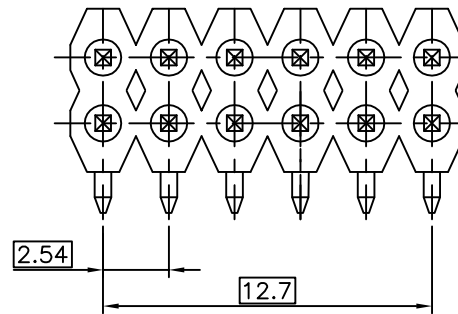
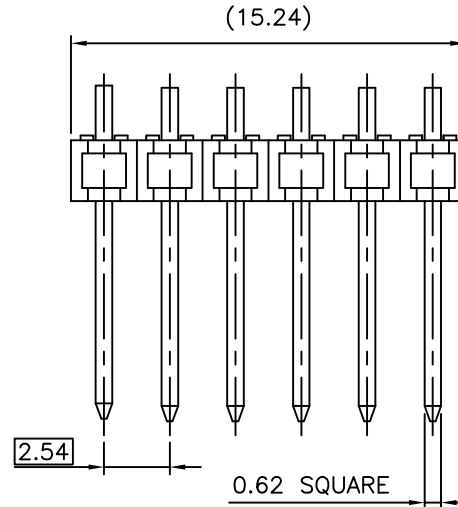
STYLE	DIM "A"	DIM "B"
01	5.8	2.5
02	8.5	1.6
03	11.0	2.5

PLATING

8 = 0.38µm GOLD/GXT ON CONTACT AREA  
3.81µm TIN-LEAD ON TAIL

4 = 2.0µm TIN MIN FULL PLATED

- WHEN "LF" IS REQUIRED, 2µm MATTE  
TIN OVER 1.27µm MIN NICKEL IS  
PROVIDED INSTEAD OF TIN-LEAD



NOTES:

1. HOUSING MAT'L : HIGH TEMPERATURE THERMOPLASTIC. UL94V-0 COLOR: BLACK
2. PIN MATERIAL : PHOSPHOR BRONZE
3. 12N MIN RETENTION IN EITHER DIRECTION
4. PRODUCT PACKAGED IN POLY BAGS.
5. RoHS COMPATIBLE PRODUCT SPECIFICATIONS
  - a - MANUFACTURING PROCESS COMPATIBILITY
    - THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C ±5°C SOLDER BATH TEMPERATURE FOR 5 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.6mm MIN THICK CIRCUIT BOARD.
  - b - LABELLING:
    - MEETS PACKAGING SPECS AS PER GS-14-920
  - c - LEGAL STATEMENT : SEE GS-22-008

mat'l. code		surface	tolerance	projection	product family
		ISO 1302	ISO 406 ISO 1101		BSTIK
ltr		tolerances unless otherwise specified		title	
A	F06-0109	LMU	06.01.17	HDR SR RA	
B	F06-0207	LMU	06.07.27	BODY DR	
C	F07-0182	LMU	07.05.09	scale 5:1	
D	F08-0148	RTR	08.03.31	dwg no	
E	F10-0059	LMU	10.05.31	sheet 1 of 1 size	
		chr	L.MULIN	10007607 A3	
		appd	J.COMPAGNON	type	
sheet		revision		CUSTOMER Drawing	
index		sheet			